



KE-3476

Shin-Etsu Silicones of America, Inc.
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Product Description

Shin-Etsu's KE-3476 is a fast, single component, room-temperature curing conformal coating that will cure to form a durable and flexible elastomer for protecting electronic components. KE-3476 is suitable for selective spray coating, mass coating, and flow coating, making it ideal for coating circuit boards.

Product Features

- Fast cure
- Single component
- Room-temperature cure
- Low odor and non-corrosive
- Excellent unprimed adhesion to most substrates

Typical Applications

- Coating circuit boards and other electronic components

Typical Properties

Type	Conformal Coating
Cure Type	Condensation
One/Two Component	One
Color	Translucent, White
Density @ 23C (g/cm ³)	1.03
Viscosity (Pa·s)	11.00
Cure Conditions	7days @ 23C/50% RH
Tack Free Time (min)	6
Shore A Hardness	25
Tensile Strength (MPa)	1.20
% Elongation	240
Usable Temperature Range (C)	-40 to +180

Note: Values are not for specification purposes.

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